

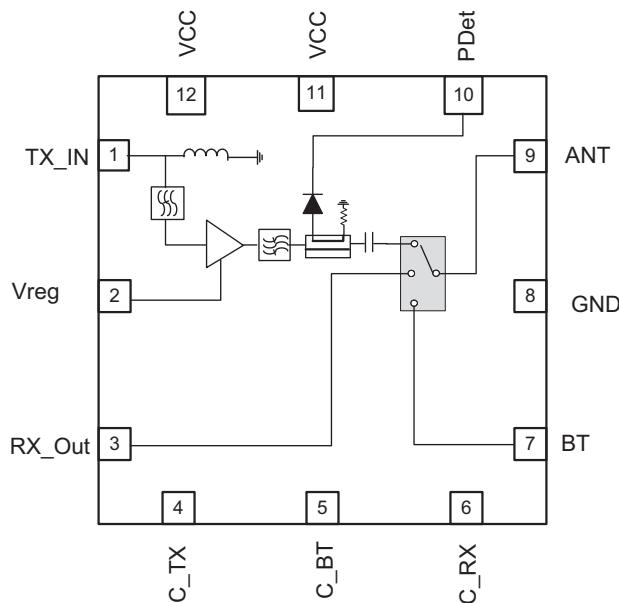


Features

- Integrated 2.4GHz to 2.5GHz b/g/n Amplifier, SP3T Switch, and Power Detector Coupler
- Single Supply Voltage 3.0V to 4.8V
- Output Power:
11b=23dBm Meeting Spectral Mask
11n=20dBm at <2.5% EVM
- Low Height Package, Suited for SiP and CoB Designs

Applications

- Cellular handsets
- Mobile devices
- Tablets
- Consumer electronics
- Gaming
- Netbooks/Notebooks
- TV/monitors/video
- SmartEnergy



Functional Block Diagram

Product Description

The RF5395 provides an integrated front-end solution for WiFi 802.11b/g/n and Bluetooth® systems. The ultra small form factor package and integrated matching greatly reduces the number of external components and layout area in the customer application. This simplifies the total Front-end solution by reducing the bill of materials, system footprint, and assembly cost.

The RF5395 integrates a 2.4GHz Power Amplifier (PA), 2170MHz notch filter for coexistence with cellular radios, second harmonic attenuation, power detector coupler for improved accuracy, and a SP3T switch capable of simultaneous reception for WiFi and Bluetooth®. The device is provided in a 2.5mmx2.5mmx0.5mm, 12-pin package. This module meets or exceeds the RF Front-end needs of IEEE 802.11b/g/n WiFi RF systems.

Ordering Information

RF5395SQ	Standard 25-piece bag
RF5395SR	Standard 100-piece bag
RF5395TR7	Standard 2500-piece reel (13")
RF5395PCK-410	Fully Assembled Evaluation Board with 5-piece Sample

Optimum Technology Matching® Applied

☐ GaAs HBT	☐ SiGe BiCMOS	☒ GaAs pHEMT	☐ GaN HEMT
☐ GaAs MESFET	☐ Si BiCMOS	☐ Si CMOS	☐ RF MEMS
☒ InGaP HBT	☐ SiGe HBT	☐ Si BJT	☐ LDMOS

Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage	-0.5 to +5.5	V _{DC}
Power Control Voltage (PA _{ENABLE})	-0.5 to 3.6	V _{DC}
DC Supply Current	700	mA
Input RF Power	+5	dBm
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-40 to +150	°C
Moisture Sensitivity	MSL2	



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

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RFMD Green: RoHS compliant per EU Directive 2002/95/EC, halogen free per IEC 61249-2-21, < 1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Compliance					IEEE802.11b/g/n Standards; FCC CFG 15.247, .205, .209; EN and JDEC.
Transmit					
Nominal Operating Conditions					V _{CC} =3.3V to 4.2V, V _{REG} =2.85V to 2.95V, Switch Control voltage=2.7V to 3.6V, Temp= -10°C to +70°C, Freq=2.412GHz to 2.484GHz, Unless otherwise noted.
Frequency Range	2.4		2.5	GHz	Test frequency range: 2412MHz to 2484MHz
Power Supply	3.0	3.3	4.8	V	
	2.7			V	Derated performance
V _{REG} Voltage					
ON	2.85	2.9	2.95	V	
OFF	0		0.2	V	
Output Power					
11n	18.5	19		dBm	V _{CC} ≥3.0V OFDM 54Mbps
11n	19.5	20		dBm	V _{CC} ≥3.3V OFDM 54Mbps
11g	20	20.5		dBm	V _{CC} ≥3.3V OFDM 54Mbps
11b	22	23		dBm	11Mbps, CCK, V _{CC} ≥3.0V
EVM					
11n		2.5	3	%	P _{OUT} =20dBm; V _{CC} ≥3.3V; 54Mbps OFDM; Room Temp
		2.5	3	%	P _{OUT} =19.5dBm; V _{CC} ≥3.3V; 54Mbps OFDM; Over Temp Range
		2.5	3	%	P _{OUT} =19dBm; V _{CC} ≥3.0V; 54Mbps OFDM; Room Temp
		2.5	3	%	P _{OUT} =18.5dBm; V _{CC} ≥3.0V; 54Mbps OFDM; Over Temp Range
11g		3.5	4	%	P _{OUT} =20.5dBm; V _{CC} ≥3.3V; 54Mbps OFDM; Room Temp
		3.5	4	%	P _{OUT} =20dBm; V _{CC} ≥3.3V; 54Mbps OFDM; Over Temp Range
Adjacent Channel Power					11b; CCK 11Mbps; at rated power (note 3)
ACP1		-36	-33	dBc	fc +/- 11MHz; V _{CC} ≥3.0V
ACP2		-56	-52	dBc	fc +/- 22MHz; V _{CC} ≥3.0V

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Transmit (continued)					
Gain	24	25	27	dB	At rated P _{OUT}
	22	25	29	dB	Over Temp Range, Frequency, and Voltage
Gain Variance Slope					
Channel 20MHz BW	-0.5		+0.5	dB	
Frequency 100MHz BW	-2		+2	dB	In-Band variance 2.4GHz to 2.5GHz
Out of Band Gain					
2170MHz	6	8		dBc	CW signal, nominal conditions
Power Detector					
Output Power Range	0		25	dBm	
Voltage Range	0.1		1.5	V _{DC}	
Filter Bandwidth		0.5		MHz	
Sensitivity					
P _{OUT} < 10dBm	10			mV/dB	
P _{OUT} > 10dBm	20			mV/dB	
Voltage Target at 20dBm P _{OUT}	0.65	0.7	0.75	V	11g, over supply voltage, room temp
Voltage Target at 23dBm P _{OUT}		0.85	1	V	11b, over supply voltage, room temp
Load Variation			±200	mV	up to 3:1 VSWR
Current Consumption					
Quiescent		170		mA	Nominal
	125		250	mA	All Conditions
Operating		250	295	mA	11g/n 64QAM, P _{OUT} =20dBm; nominal conditions
		250	325	mA	11g/n 64QAM, P _{OUT} =19.5dBm; all conditions
		300	410	mA	11b CCK 11Mbps, P _{OUT} =23dBm; all conditions
FEM Leakage Current			500	nA	V _{CC} =ON, V _{REG} OFF ≤0.2V, room temp
V _{REG} Current		3	5	mA	V _{REG} ON ≥2.85V, P _{OUT} =20dBm; all conditions
V _{REG} Leakage Current			50	nA	V _{REG} OFF ≤0.2V, room temp
Noise Figure		8	9	dB	
Input Return Loss	8	10		dB	
Thermal Resistance		47		°C/W	V _{CC} =4.8V, V _{REG} =2.95V, C _{TX} =3.3V, C _{RX} =C _{BT} =GND, P _{OUT} =20dBm, Modulation=OFDM 11g, Freq=2.45GHz, DC=100%, T=85 °C
Harmonics					P _{OUT} =23dBm, 1Mbps, CCK BW=1MHz, uo to 3:1 load
Second			-20	dBm	4.80GHz to 5.00GHz, V _{CC} =3.3V, Temp=25 °C
Third			-20	dBm	7.20GHz to 7.50GHz, V _{CC} =3.3V, Temp=25 °C
Stability					
Output VSWR	4:1				No spurs above -43dBm from 0dBm to 23dBm, all phase angles, no spurious or oscillations.
Ruggedness					
Output VSWR	10:1				
Input Power	0			dBm	CW Input Power
Input Port Impedance		50		Ω	
Turn-On/Off Time			1	usec	Output stable to within 90% of final gain

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
2.4GHz Receive					
Frequency	2.4		2.5	GHz	Test frequency range: 2412 MHz to 2484 MHz
Insertion Loss		0.8	1.2	dB	Over supply voltage, temp range and frequency
Input P1dB	22			dBm	
Passband Ripple					
WiFi RX Mode	-0.2		+0.2	dB	
WiFi RX/BT Mode	-0.2		+0.2	dB	
WiFi RX Port Return Loss	10	12		dB	
WiFi RX Port Impedance		50		Ω	
Bluetooth®					
Frequency	2.4		2.5	GHz	Test frequency range: 2412 MHz to 2484 MHz
Insertion Loss					
BT TX/RX Loss		0.8	1.2	dB	Over supply voltage, temp range and frequency
Bluetooth Port Return Loss	10			dB	
Bluetooth Port Impedance		50		Ω	
Input P1dB	22			dBm	
Other Requirements					
Antenna Port Impedance		50		Ω	
Return Loss	10	12		dB	In WiFi RX or BT Mode
Isolation					
ANT to RX	20			dB	At rated P _{OUT} in TX Mode
Switch Control Voltage					
Low	0		0.2	V	
High	2.7		3.6	V	
Switch Control Current					
Low			0.5	uA	
High			100	uA	
ESD					
Human Body Model	1000			V	Pin-GND
Charge Device Model	1000			V	JESD22-C101
Case Temperature	-10		+70	°C	Full Performance
Extreme Case Temperature	-40		+85	°C	Reduced Performance

Note 1: The PA must operate with gated bias voltage input at 1% to 99% duty cycle.

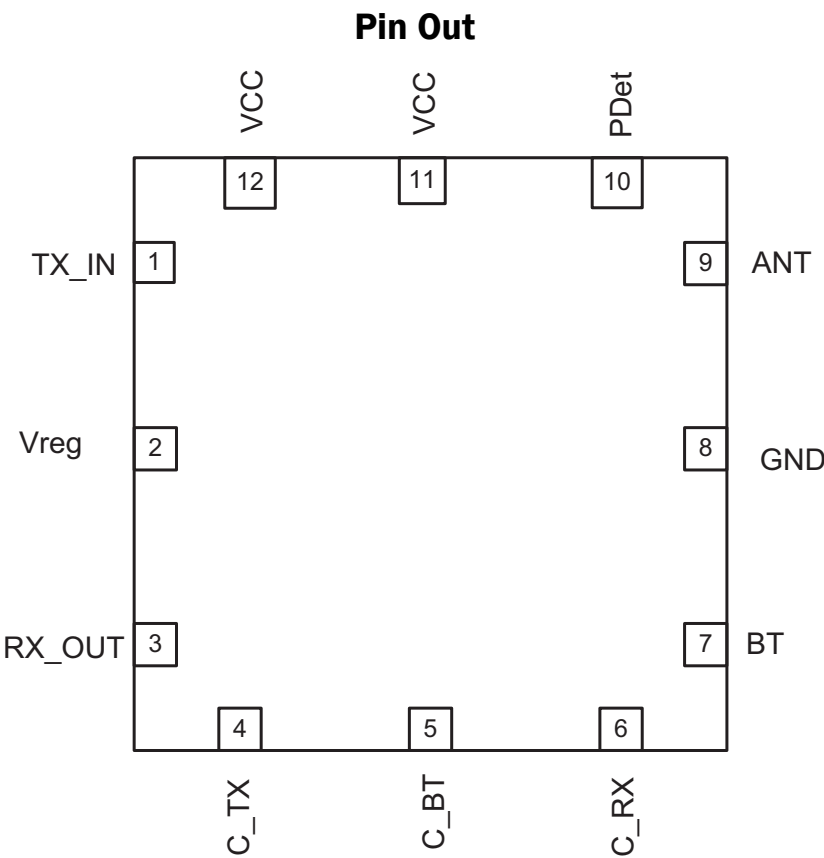
Note 2: No external matching components.

Note 3: The output power for channels 1 and 11 may be reduced to meet FCC restricted band requirements.

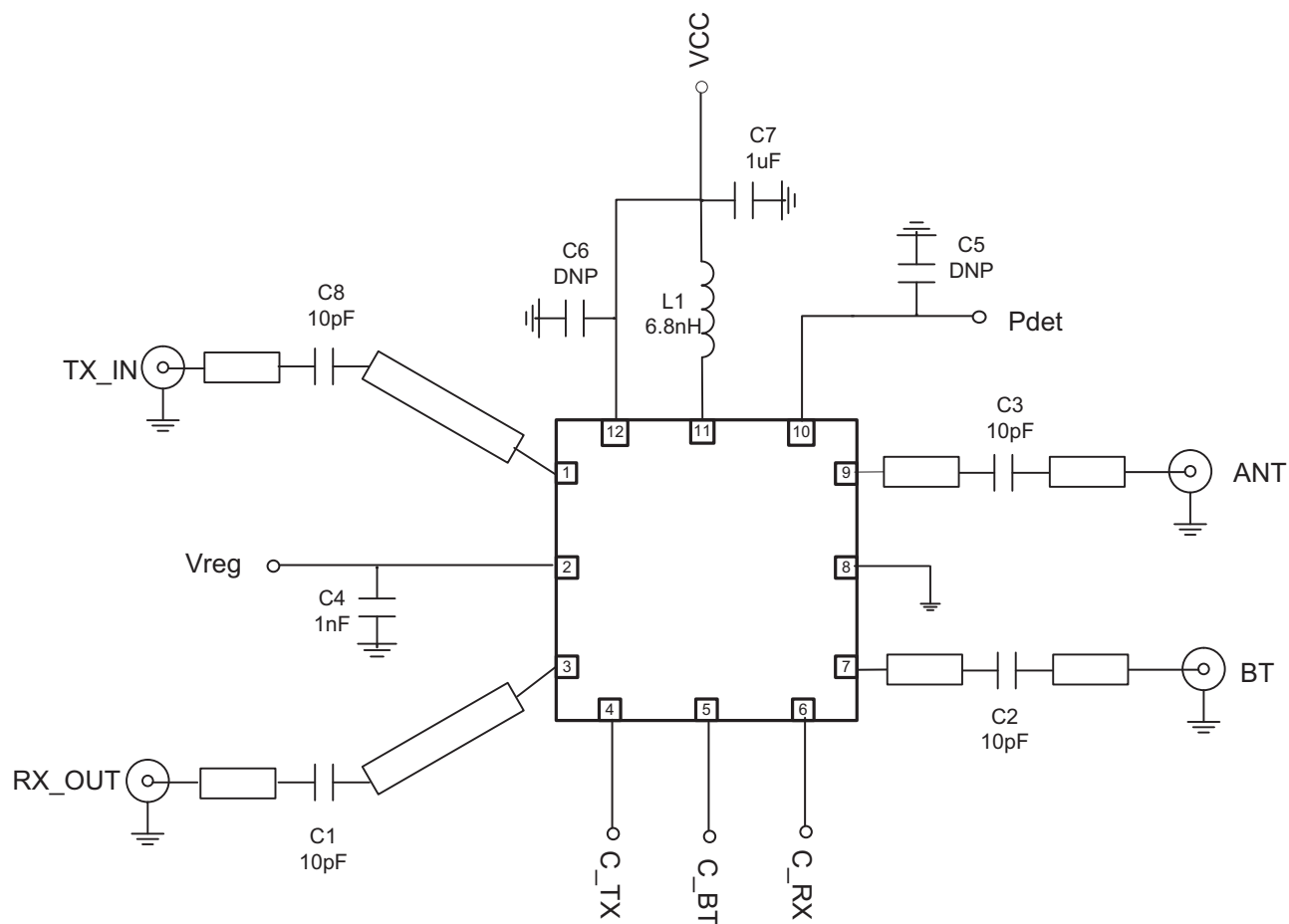
Switch Control Logic

Mode	C_TX	C_RX	C_BT	V _{REG}
Transmit	High	Low	Low	High
Receive	Low	High	Low	Low
Bluetooth®	Low	Low	High	Low
Simultaneous	Low	High	High	Low

Pin	Function	Description
1	TX_IN	RF input for the 802.11b/g/n PA matched to 50Ω. External DC block is required.
2	Vreg	Regulated voltage for the PA bias control circuit. An external bypass capacitor is needed for noise decoupling and stability.
3	RX_Out	RF output for the 802.11b/g/n LNA matched to 50Ω. External DC block is required.
4	C_TX	Control pin for WLAN transmit mode. See logic table for additional settings.
5	C_BT	Control pin for Bluetooth mode. See logic table for additional settings.
6	C_RX	Control pin for Receive mode. See logic table for additional settings.
7	BT	RF bidirectional port for <i>Bluetooth</i> ® matched to 50Ω. External DC block is required.
8	GND	Ground connection.
9	ANT	RF bidirectional antenna port matched to 50Ω. External DC block is required.
10	PDET	Transmit power detector. Dector voltage varies with output power and may need external bypass capacitor.
11	Vcc	PA voltage supply. See applications schematic for biasing and bypassing components.
12	Vcc	Same as pin-11
Pkg Base	GND	Ground connection. The backside of the package should be connected to the ground plane through a short path, i.e., PCB vias under the device are recommended.

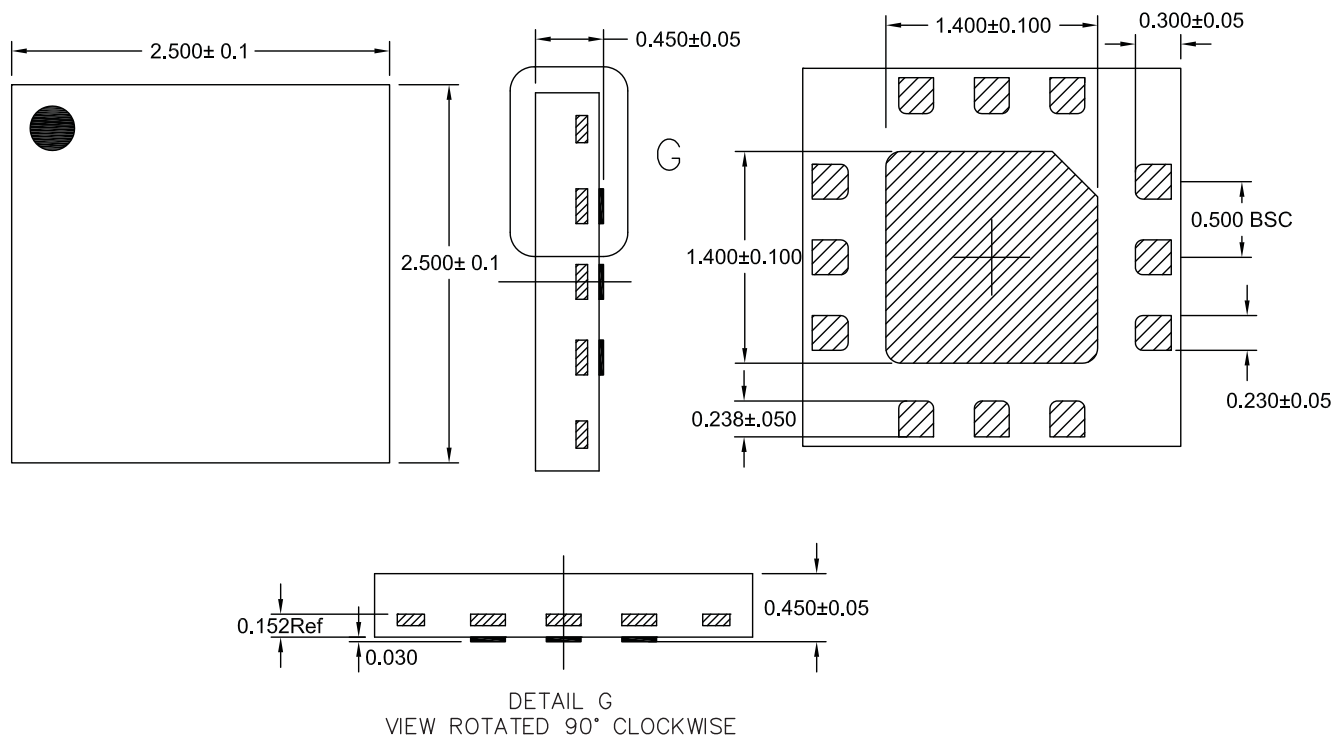


Application Schematic



Note: Components C5 and C6 may not be needed in the final schematic. This will be dependent on board layout and noise coupling to these pins.

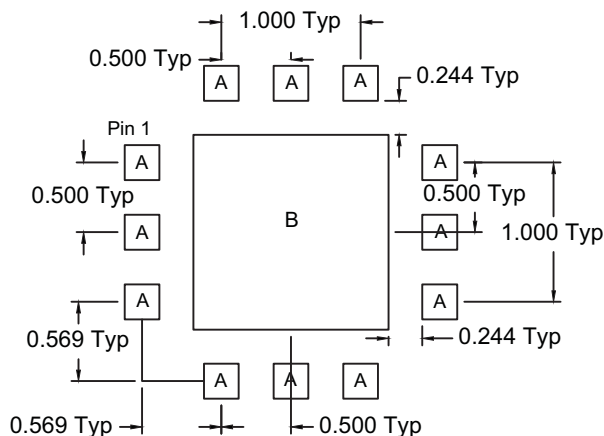
Package Outline Drawing



- 1) PIN 1 INDICATOR SHADED AREA
- 2) CHAMFERED AREA IS PIN 1 INDICATOR

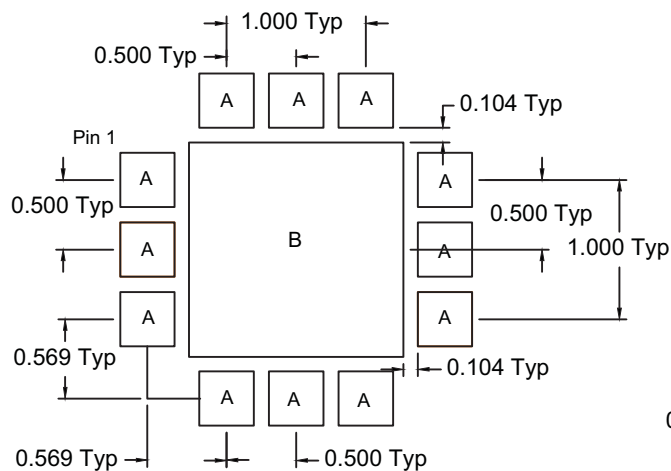
PCB Recommendations

A = 0.250 x 0.250 mm Typ
B = 1.400 x 1.400 mm 10% Rounded Rectangle



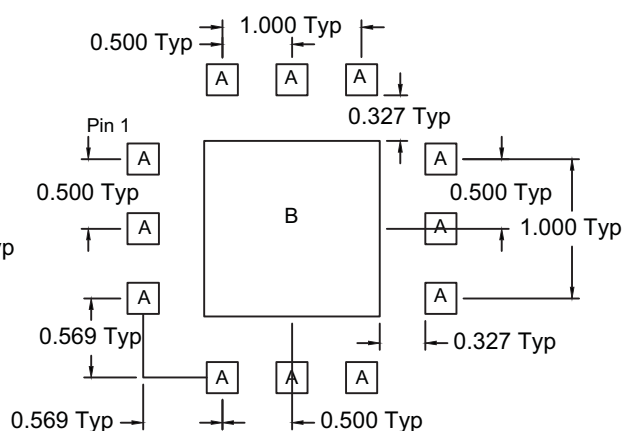
PCB METAL LAND PATTERN

A = 0.390 x 0.390 mm Typ
B = 1.540 x 1.540 mm 10% Rounded Rectangle



PCB SOLDER MASK LAND PATTERN

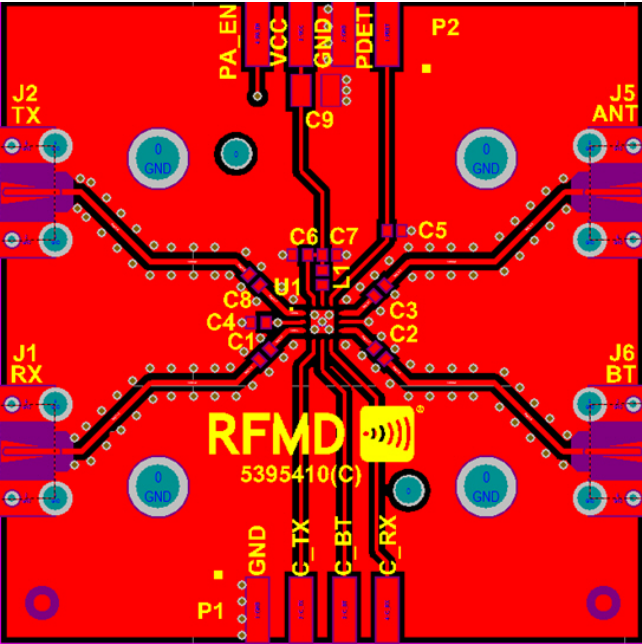
A = 0.225 x 0.225 mm Typ
B = 1.260 x 1.260 mm 10% Rounded Rectangle



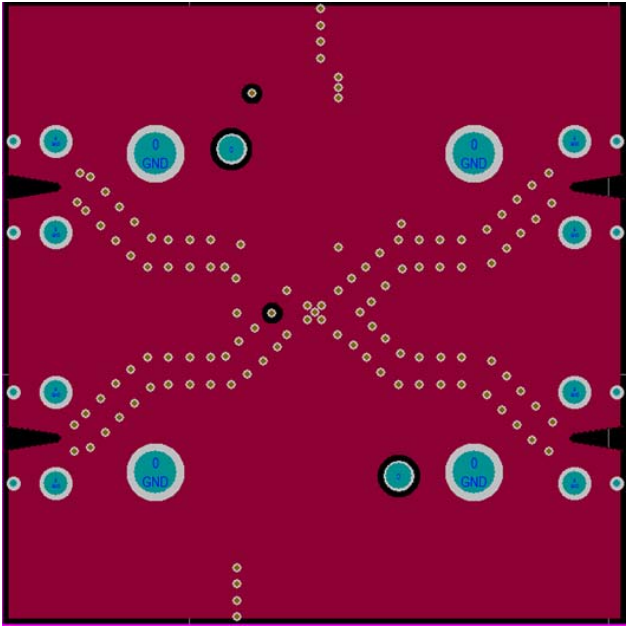
PCB STENCIL PATTERN

Thermal vias for center slug "B" should be incorporated into the PCB design. The number and size of thermal vias will depend on the application, the power dissipation, and the electrical requirements. Example of the number and size of vias can be found on the RFMD evaluation board layout.

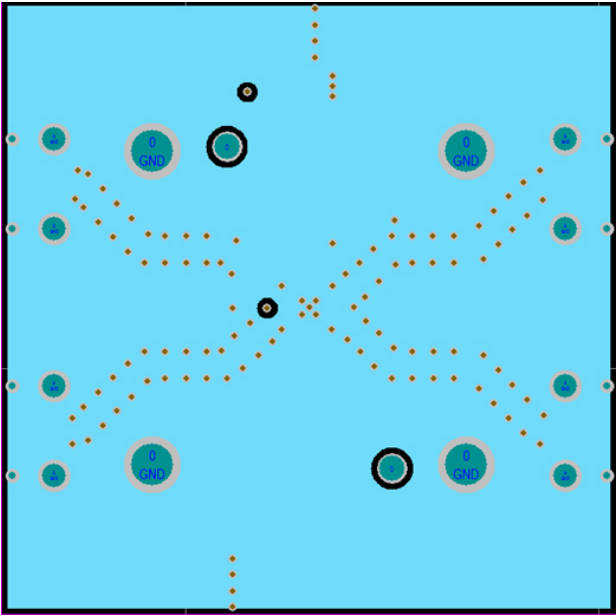
RF5395 Evaluation Board Plots



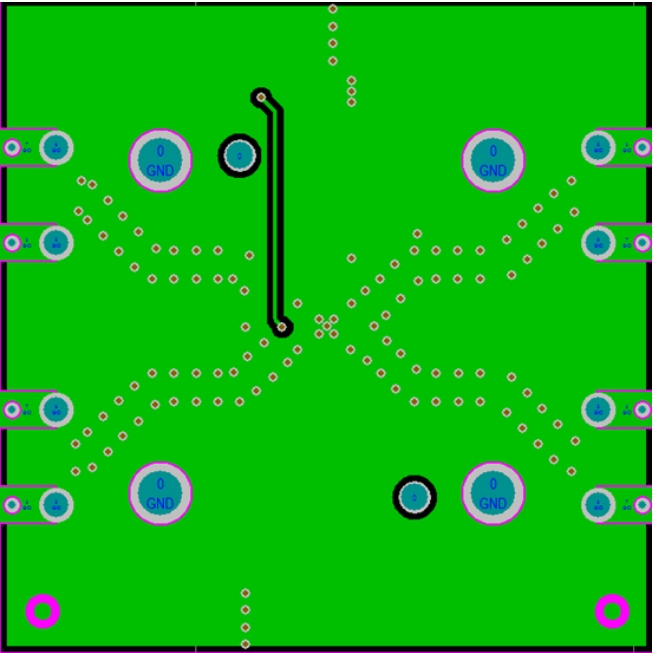
Top Layer



Mid Layer 1

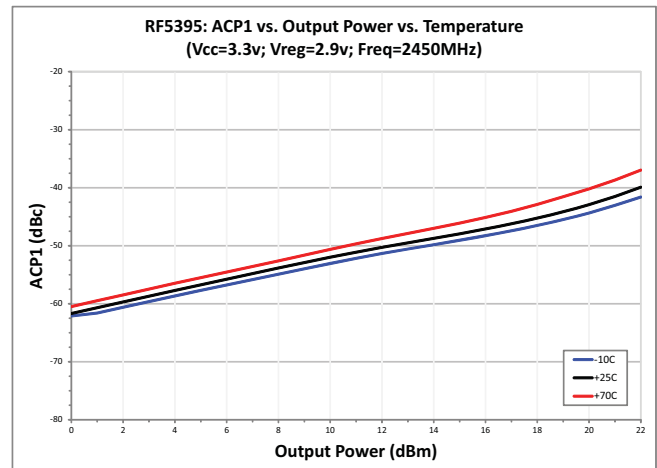
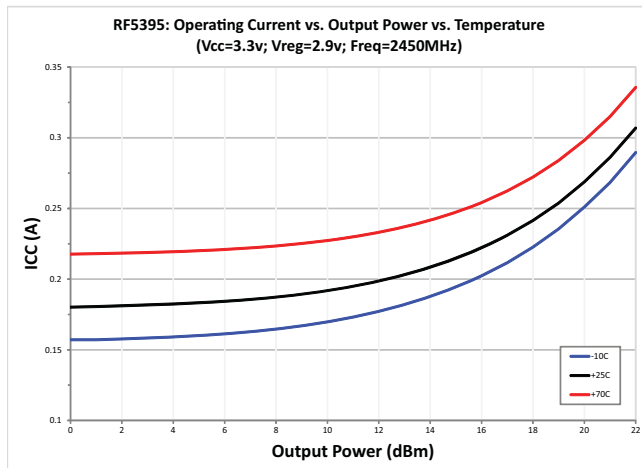
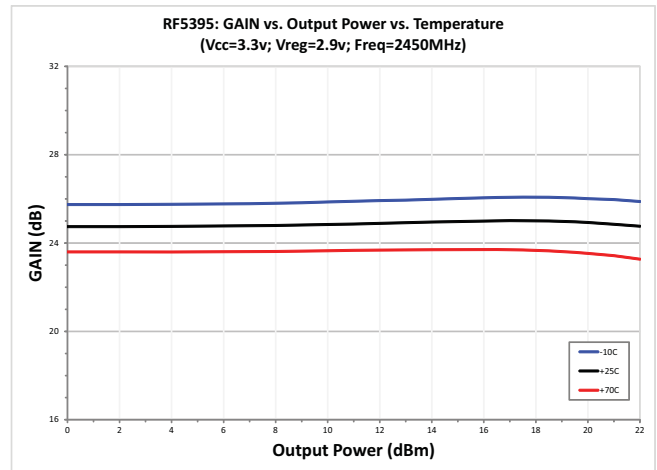
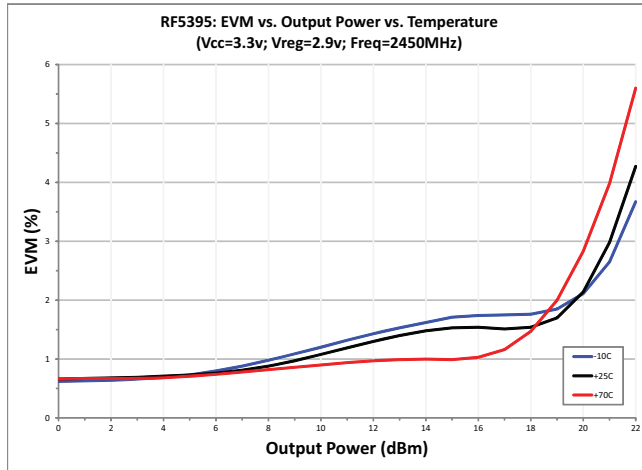


Mid Layer 2

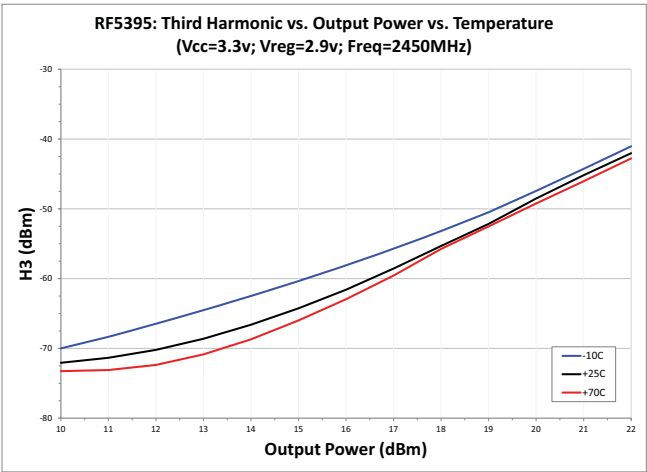
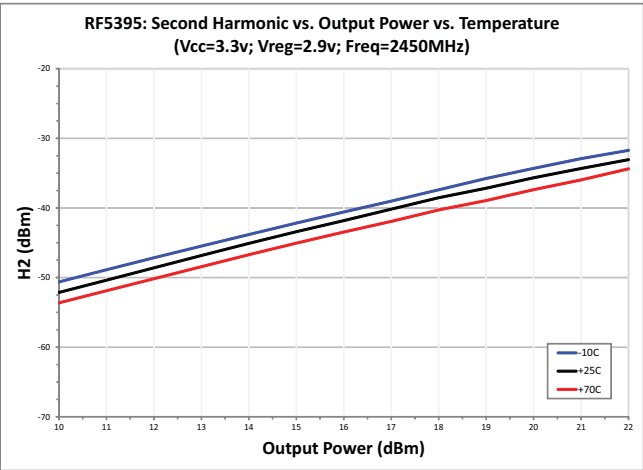
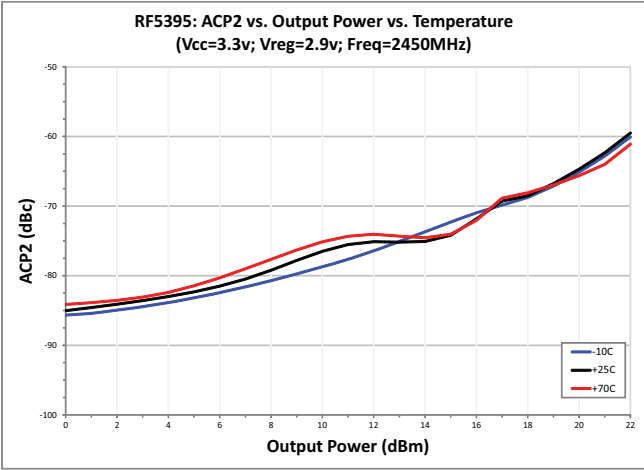


Bottom Layer

RF5395 Performance Plots



RF5395 Performance Plots



RF5395 Performance Plots

